



Smart Highside High Current Power Switch

Reversave™

 Reverse battery protection by self turn on of power MOSFET

Features

- Overload protection
- Current limitation
- Short circuit protection
- Over temperature protection
- Over voltage protection (including load dump)
- Clamp of negative voltage at output
- Fast deenergizing of inductive loads 1)
- Low ohmic inverse current operation
- Diagnostic feedback with load current sense
- Open load detection via current sense
- Loss of V_{bb} protection²⁾
- Electrostatic discharge (ESD) protection
- Green product (RoHS compliant)
- AEC qualified

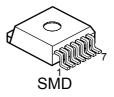
Application

- Power switch with current sense diagnostic feedback for up to 48 V DC grounded loads
- Most suitable for loads with high inrush current like lamps and motors; all types of resistive and inductive loads
- Replaces electromechanical relays, fuses and discrete circuits

Product Summary

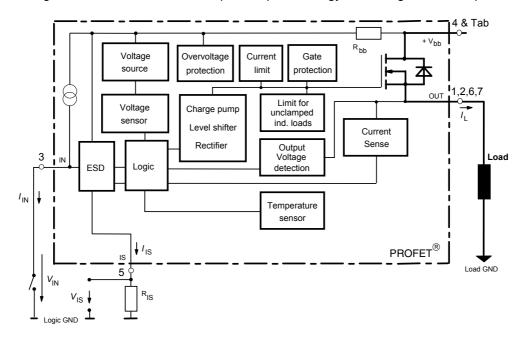
| Overvoltage protection | V _{bb(AZ)} | 70 | V |
|----------------------------------|-------------------------------------|--------|-----------|
| Output clamp | $V_{ON(CL)}$ | 62 | V |
| Operating voltage | $V_{ m bb(on)}$ | 5.058 | V |
| On-state resistance | RON | 9 | $m\Omega$ |
| Load current (ISO) | <i>I</i> L(ISO) | 44 | Α |
| Short circuit current limitation | <i>I</i> L(SC) | 90 | Α |
| Current sense ratio | <i>I</i> L : <i>I</i> _{IS} | 13 000 | |

PG-TO220-7-4



General Description

N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS® chip on chip technology. Providing embedded protection functions.



¹⁾ With additional external diode.

²⁾ Additional external diode required for energized inductive loads (see page 9).



| Pin | Symbol | | Function |
|-----|--------|---|---|
| 1 | OUT | 0 | Output to the load. The pins 1,2,6 and 7 must be shorted with each other especially in high current applications! 3) |
| 2 | OUT | 0 | Output to the load. The pins 1,2,6 and 7 must be shorted with each other especially in high current applications! 3) |
| 3 | IN | I | Input, activates the power switch in case of short to ground |
| 4 | Vbb | + | Positive power supply voltage, the tab is electrically connected to this pin. In high current applications the tab should be used for the V_{bb} connection instead of this pin ⁴). |
| 5 | IS | S | Diagnostic feedback providing a sense current proportional to the load current; zero current on failure (see Truth Table on page 7) |
| 6 | OUT | 0 | Output to the load. The pins 1,2,6 and 7 must be shorted with each other especially in high current applications! 3) |
| 7 | OUT | 0 | Output to the load. The pins 1,2,6 and 7 must be shorted with each other especially in high current applications! $^{3)}$ |

Maximum Ratings at $T_j = 25$ °C unless otherwise specified

| Parameter | Symbol | Values | Unit |
|---|--------------------------------------|--------------|------|
| Supply voltage (over voltage protection see page 4) | $V_{ m bb}$ | 62 | V |
| Supply voltage for full short circuit protection, (E _{AS} limitation see diagram on page 10) $T_{j,\text{start}}$ =-40+150°C: | $V_{ m bb}$ | 58 | V |
| Load current (short circuit current, see page 5) | <i>I</i> L | self-limited | Α |
| Load dump protection $V_{\text{LoadDump}} = U_{\text{A}} + V_{\text{S}}$, $U_{\text{A}} = 13.5 \text{ V}$ | | | |
| $R_1^{5} = 2 \Omega$, $R_L = 0.23 \Omega$, $t_d = 200 \text{ms}$, | V _{Load dump} ⁶⁾ | 80 | V |
| IN, IS = open or grounded | | | |
| Operating temperature range | $T_{\rm j}$ | -40+150 | °C |
| Storage temperature range | T_{stg} | -55+150 | |
| Power dissipation (DC), T _C ≤ 25 °C | P_{tot} | 170 | W |
| Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$, $T_{j,start} = 150^{\circ}C$, $T_{C} = 150^{\circ}C$ const., $I_{L} = 20$ A, $Z_{L} = 6$ mH, 0Ω , see diagrams on page 10 | E _{AS} | 1.2 | J |
| Electrostatic discharge capability (ESD) Human Body Model acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993, C = 100 pF, R = 1.5 k Ω | V _{ESD} | 4.0 | kV |
| Current through input pin (DC) | I _{IN} | +15, -250 | mA |
| Current through current sense status pin (DC) | I _{IS} | +15,-250 | |
| see internal circuit diagrams on page 7 and 8 | | | |

Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

Infineon Technologies AG

Otherwise add up to 0.7 m Ω (depending on used length of the pin) to the R_{ON} if the pin is used instead of the tab.

⁵⁾ R_{\parallel} = internal resistance of the load dump test pulse generator.

⁶⁾ V_{Load dump} is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.



Thermal Characteristics

| Parameter and Conditions | | Symbol | Values | | | Unit |
|--------------------------|-------------------------------|----------------|--------|-----|------|------|
| | | | min | typ | max | |
| Thermal resistance | chip - case: | $R_{thJC^{7}}$ | | - | 0.75 | K/W |
| j | unction - ambient (free air): | R_{thJA} | | 60 | | |
| SMD |) version, device on PCB 8): | | | 33 | | |

Electrical Characteristics

| Parameter and Conditions | Symbol | Values | | Unit | |
|--|--------|--------|-----|------|---|
| at $T_j = -40 \dots +150 ^{\circ}\text{C}$, $V_{bb} = 24 ^{\circ}\text{V}$ unless otherwise specified | | min | typ | max | · |

Load Switching Capabilities and Characteristics

| Load Switching Capabilities and Characteristics | | | | | |
|---|-------------------------|-----|------|-----|------|
| On-state resistance (Tab to pins 1,2,6,7, see | | | | | |
| measurement circuit page 7) $I_L = 20 \text{ A}, T_j = 25 ^{\circ}\text{C}$: | R_{ON} | | 7.2 | 9 | mΩ |
| $V_{IN} = 0$, $I_L = 20 \text{ A}$, $T_j = 150 ^{\circ}\text{C}$: | | | 14.6 | 17 | |
| $I_{L} = 80 \text{ A}, T_{j} = 150 ^{\circ}\text{C}$: | | | | 17 | |
| $V_{\rm bb} = 6 \text{V}, I_{\rm L} = 20 \text{A}, T_{\rm j} = 150 ^{\circ} \text{C}$: | R _{ON(Static)} | | 17 | 22 | |
| Nominal load current 9) (Tab to pins 1,2,6,7) | I _{L(ISO)} | 38 | 44 | - | Α |
| ISO 10483-1/6.7: $V_{ON} = 0.5 \text{ V}$, $T_{C} = 85 ^{\circ}\text{C}^{-10}$ | | | | | |
| Nominal load current 9), device on PCB 8) | | | | | |
| $T_{A} = 85 \text{ °C}, T_{j} \le 150 \text{ °C } V_{ON} \le 0.5 \text{ V},$ | I _{L(NOM)} | 9.9 | 11.1 | | Α |
| Maximum load current in resistive range | , | | | | |
| (Tab to pins 1,2,6,7) $V_{ON} = 1.8 \text{ V}, T_{C} = 25 ^{\circ}\text{C}$: | $I_{L(Max)}$ | 185 | | | _ |
| see diagram on page 13 $V_{ON} = 1.8 \text{ V}, T_{C} = 150 ^{\circ}\text{C}$: | | 105 | | | Α |
| Turn-on time ¹¹⁾ $I_{IN} \int to 90\% V_{OUT}$: | <i>t</i> on | 50 | | 400 | μs |
| Turn-off time $I_{IN} \perp$ to 10% V_{OUT} : | $t_{ m off}$ | 30 | | 110 | |
| $R_L = 1 \Omega$, $T_j = -40 + 150$ °C | | | | | |
| Slew rate on $^{11)}$ (10 to 30% V_{OUT}) | d V/dt _{on} | 1.0 | 1.5 | 2.2 | V/μs |
| $R_{\rm L} = 1 \Omega$ | | | | | |
| Slew rate off $^{11)}$ (70 to 40% $V_{\rm OUT}$) | -d V/dt _{off} | 1.1 | 1.9 | 2.6 | V/μs |
| $R_{\rm L} = 1 \Omega$ | | | | | |
| | | | | | |

Thermal resistance R_{thCH} case to heatsink (about 0.5 ... 0.9 K/W with silicone paste) not included!

below the state of the stat

⁹⁾ not subject to production test, specified by design

 $^{^{10)}}$ $T_{\rm J}$ is about 105°C under these conditions.

See timing diagram on page 14.



 $I_{IN} = 0, V_{bb} = 35V$

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| Parameter and Conditions | | Symbol | | Values | ; | Unit |
|---|----------------------------------|----------------------|-----|--------|-----|-----------|
| at $T_j = -40 \dots +150 ^{\circ}\text{C}$, $V_{bb} = 24 ^{\circ}\text{V}$ unless otherw | vise specified | | min | typ | max | |
| Inverse Load Current Operation | | | | | | |
| On-state resistance (Pins 1,2,6,7 to pin 4) | | | | | | |
| $V_{\text{bIN}} = 12 \text{ V}, I_{\text{L}} = -20 \text{ A}$ | $T_j = 25 ^{\circ}\text{C}$: | $R_{ m ON(inv)}$ | | 7.2 | 9 | $m\Omega$ |
| see diagram on page 10 | $T_{j} = 150 ^{\circ}\text{C}$: | | | 14.6 | 17 | |
| Nominal inverse load current (Pins 1,2,6, | 7 to Tab) | $I_{L(inv)}$ | 50 | 60 | | Α |
| $V_{ON} = -0.5 \text{V}, T_{C} = 85 ^{\circ}\text{C}$ | | | | | | |
| Drain-source diode voltage ($V_{out} > V_{bb}$) $I_L = -20 \text{ A}, I_{IN} = 0, T_I = +150 ^{\circ}\text{C}$ | | -V _{ON} | | 0.6 | 0.7 | mV |
| | | 1 | | | | |
| Operating Parameters | | | | | | |
| Operating voltage $(V_{IN} = 0)^{12}$ | | $V_{ m bb(on)}$ | 5.0 | | 58 | V |
| Under voltage shutdown 13)14) | | $V_{bIN(u)}$ | 1.5 | 3.0 | 4.5 | V |
| Under voltage start of charge pump | | | | | | |
| see diagram page 15 | | $V_{bIN(ucp)}$ | 3.0 | 4.5 | 6.0 | V |
| Over voltage protection 15) | $T_{\rm j}$ =-40°C: | $V_{bIN(Z)}$ | 68 | | | V |
| $I_{bb} = 15 \mathrm{mA}$ $T_{\mathrm{j}} = 2$ | 25+150°C: | | 70 | 72 | - | |
| Standby current $T_j =$ | -40+25°C: | I _{bb(off)} | | 15 | 25 | μΑ |

 $T_i = 150^{\circ}C$:

¹²⁾ If the device is turned on before a V_{bb} -decrease, the operating voltage range is extended down to $V_{bIN(u)}$. For the voltage range 0..58 V the device provides embedded protection functions against overtemperature and short circuit.

not subject to production test, specified by design

 $V_{\text{bIN}} = V_{\text{bb}} - V_{\text{IN}}$ see diagram on page 15. When V_{bIN} increases from less than $V_{\text{bIN}(u)}$ up to $V_{\text{bIN}(ucp)} = 5 \text{ V}$ (typ.) the charge pump is not active and $V_{\text{OUT}} \approx V_{\text{bb}} - 3 \text{ V}$.

See also $V_{\rm ON(CL)}$ in circuit diagram on page 9.



| Parameter and Conditions | Symbol | bol Values | | | Unit |
|--|---------------------|------------|-----|-----|------|
| at $T_j = -40 \dots +150 ^{\circ}\text{C}$, $V_{bb} = 24 ^{\circ}\text{V}$ unless otherwise specified | | min | typ | max | |
| Protection Functions ¹⁶⁾ | • | • | | | |
| Short circuit current limit (Tab to pins 1,2,6,7) | | | | | |
| $V_{ON} = 24 \text{ V}$, time until shutdown max. $300 \mu\text{s}$ $T_{C} = -40 ^{\circ}\text{C}$: | I _{L(SC)} | | 90 | 180 | Α |
| see page 8 and 13 $T_c = 25^{\circ}C$: | I _{L(SC)} | | 90 | | |
| $T_{\rm c} = +150^{\circ}{\rm C}$: | I _{L(SC)} | 50 | 80 | | |
| Short circuit shutdown delay after input current positive slope, $V_{\rm ON} > V_{\rm ON(SC)}^{17)}$ min. value valid only if input "off-signal" time exceeds 30 μ s | $t_{\sf d(SC)}$ | 80 | | 350 | μs |
| Output clamp (inductive load switch off) at $V_{\text{OUT}} = V_{\text{bb}} - V_{\text{ON(CL)}}$ (e.g. over voltage) $I_{\text{L}} = 40 \text{ mA}$ | V _{ON(CL)} | 62 | 65 | 72 | V |
| Short circuit shutdown detection voltage ¹⁷) (pin 4 to pins 1,2,6,7) | V _{ON(SC)} | | 6 | | V |
| Thermal overload trip temperature | T _{it} | 150 | | | °C |
| Thermal hysteresis | $\Delta T_{\rm it}$ | | 10 | | K |

| Reverse battery voltage 18) | | <i>- V</i> _{bb} | | I | 42 | V |
|---|----------------------------------|--------------------------|-----|-----|------|----|
| On-state resistance (Pins 1,2,6,7 to pin 4) | $T_j = 25$ °C: | R _{ON(rev)} | | 8.8 | 10.5 | mΩ |
| V_{bb} =-12V, V_{IN} =0, I_{L} =-20A, R_{IS} =1k Ω | $T_{j} = 150 ^{\circ}\text{C}$: | , , | | | 20 | |
| Integrated resistor in V _{bb} line | $T_{j} = 25 \text{ C}$: | $R_{ m bb}$ | 90 | 120 | 135 | Ω |
| | <i>T</i> _j =150°C: | | 105 | 125 | 150 | |

¹⁶) Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

¹⁷⁾ not subject to production test, specified by design.

The reverse load current through the intrinsic drain-source diode has to be limited by the connected load (as it is done with all polarity symmetric loads). Note that under off-conditions ($I_{IN} = I_{IS} = 0$) the power transistor is not activated. This results in raised power dissipation due to the higher voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! To reduce the power dissipation at the integrated R_{th} resistor an input resistor is recommended as described on page 9.



| Parameter and Conditions | Symbol | Values | | Unit | |
|--|--------|--------|-----|------|---|
| at $T_j = -40 \dots +150 ^{\circ}\text{C}$, $V_{bb} = 24 ^{\circ}\text{V}$ unless otherwise specified | | min | typ | max | · |

Diagnostic Characteristics

| Diagnostio Grianastoriotios | | | | | | |
|--|---|--------------------------|---|--|--|----|
| Current sense ratio, static on-condition, $k_{\rm ILIS} = I_{\rm L} : I_{\rm IS}, V_{\rm ON} < 1.5 \rm V_{\rm IS} < V_{\rm OUT} - 5 \rm v, V_{\rm bIN} > 4.0 \rm V$ see diagram on page 12 $I_{\rm IN} = 0$, $I_{\rm IS} = 0$ (e.g. during deene | $I_L = 80 A, T_j = -40 ^{\circ} C$: $T_j = 25 ^{\circ} C$: $T_j = 150 ^{\circ} C$: $I_L = 20 A, T_j = -40 ^{\circ} C$: $T_j = 25 ^{\circ} C$: $T_j = 150 ^{\circ} C$: $T_j = 25 ^{\circ} C$: $T_j = 150 ^{\circ} C$: $I_L = 4 A, T_j = -40 ^{\circ} C$: $T_j = 25 ^{\circ} C$: $T_j = 150 ^{\circ} C$: rgizing of inductive loads): | <i>k</i> _{ILIS} | 11 400 11 000 11 000 11 000 11 000 10 500 10 500 11 000 9 000 10 000 | 13 000 13 000 13 000 13 000 13 000 13 000 13 000 13 000 13 000 13 000 | 14 600 14 200 16 000 15 000 14 500 17 000 15 500 15 000 22 000 18 500 | |
| Sense current saturation | | I _{IS,lim} | 6.5 | | | mA |
| Current sense leakage curre | $I_{IN} = 0$ | I _{IS(LL)} | | | 0.5 | μΑ |
| | $V_{IN} = 0, I_L < 0$: | I _{IS(LH)} | | 2 | 65 | |
| Current sense over voltage protection $T_i = -40^{\circ}\text{C}$: | | $V_{bIS(Z)}$ | 68 | | | V |
| $I_{bb} = 15 \mathrm{mA}$ | $T_{\rm j}$ = 25+150°C: | | 70 | 72 | | |
| Current sense settling time 20) | | $t_{\rm s(IS)}$ | | | 500 | μs |
| | | | | | | |

Input

| Input and operating current (see diagram page 13) IN grounded (V _{IN} = 0) | I _{IN(on)} | 0.8 | 1.5 | mA |
|---|----------------------|---------|-----|----|
| Input current for turn-off ²¹) | I _{IN(off)} | | 80 | μΑ |

If V_{ON} is higher, the sense current is no longer proportional to the load current due to sense current saturation, see $I_{IS,lim}$.

not subject to production test, specified by design

We recommend the resistance between IN and GND to be less than 0.5 k Ω for turn-on and more than 500k Ω for turn-off. Consider that when the device is switched off (I_{IN} = 0) the voltage between IN and GND reaches almost V_{bb}.



Truth Table

| | Input current | Output | Current Sense | Remark |
|------------------------|------------------|--------------------------|--------------------------------|---|
| | level | level | l _{IS} | |
| Normal | L | L | 0 | |
| operation | Н | Н | nominal | =I _L / k _{ilis} , up to I _{IS} =I _{IS,lim} |
| Very high load current | Н | Н | I _{IS, lim} | up to V _{ON} =V _{ON(Fold back)} I _{IS} no longer proportional to I _L |
| Current- limitation | Н | Н | 0 | V _{ON} > V _{ON(Fold back)} if V _{ON} >V _{ON(SC)} , shutdown will occure |
| Short circuit to | L | L | 0 | |
| GND | Н | L | 0 | |
| Over- | L | L | 0 | |
| temperature | Н | L | 0 | |
| Short circuit to | L | Н | 0 | |
| V _{bb} | Н | Н | <nominal <sup="">22)</nominal> | |
| Open load | L | Z ²³) | 0 | |
| - | Н | Н | 0 | |
| Negative output | L | L | 0 | |
| voltage clamp | | | | |
| Inverse load | L | Н | 0 | |
| current | Н | Н | 0 | |

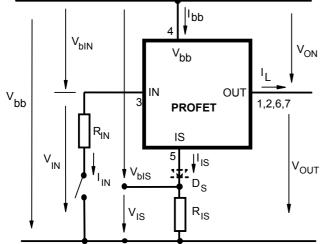
L = "Low" Level

H = "High" Level

Over temperature reset by cooling: T_i < T_{it} (see diagram on page 15)

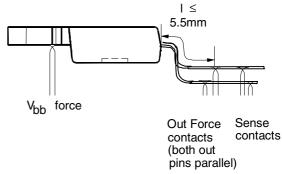
Short circuit to GND: Shutdown remains latched until next reset via input (see diagram on page 14)

Terms



Two or more devices can easily be connected in parallel to increase load current capability.

RON measurement layout



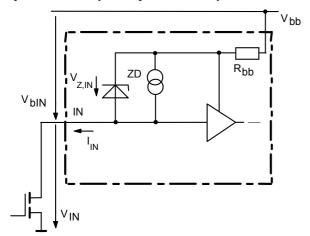
Typical Ron for SMD version is about 0.2 m Ω less than straight leads due to I ≈ 2 mm

Low ohmic short to $V_{\rm bb}$ may reduce the output current $I_{\rm L}$ and can thus be detected via the sense current $I_{\rm IS}$.

Power Transistor "OFF", potential defined by external impedance.



Input circuit (ESD protection)

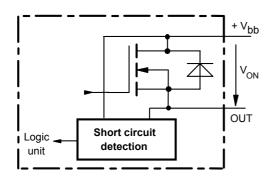


When the device is switched off ($I_{IN} = 0$) the voltage between IN and GND reaches almost V_{bb} . Use a bipolar or MOS transistor with appropriate breakdown voltage as driver.

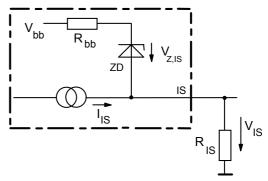
 $V_{Z,IN} = 74 \text{ V (typ)}.$

Short circuit detection

Fault Condition: $V_{ON} > V_{ON(SC)}$ (6 V typ.) and t> $t_{d(SC)}$ (80 ...300 µs).



Current sense status output

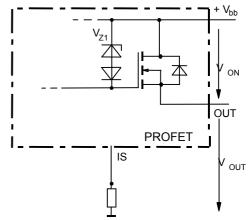


 $V_{\rm Z,IS}$ = 74V (typ.), $R_{\rm IS}$ = 1 k Ω nominal (or 1 k Ω /n, if n devices are connected in parallel). $I_{\rm S}$ = $I_{\rm L}/k_{\rm ilis}$ can be driven only by the internal circuit as long as $V_{\rm out}$ - $V_{\rm IS}$ > 5 V. If you want measure load currents up to $I_{\rm L(M)}$, $R_{\rm IS}$

should be less than $\frac{V_{\rm bb}$ - 5 V $I_{\rm L(M)}$ / $K_{\rm llis}$

Note: For large values of $R_{\rm IS}$ the voltage $V_{\rm IS}$ can reach almost $V_{\rm bb}$. See also over voltage protection. If you don't use the current sense output in your application, you can leave it open.

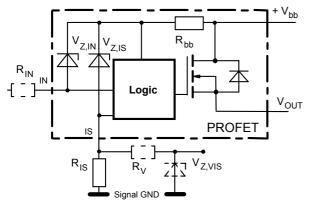
Inductive and over voltage output clamp



 V_{ON} is clamped to $V_{ON(Cl)} = 62 \text{ V}$ typ

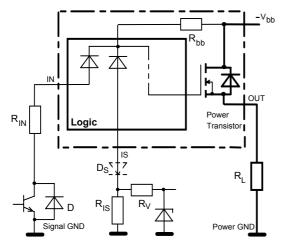


Over voltage protection of logic part



 R_{bb} = 120 Ω typ., $V_{Z,IN}$ = $V_{Z,IS}$ = 74 V typ., R_{IS} = 1 k Ω nominal. Note that when over voltage exceeds 79 V typ. a voltage above 5V can occur between IS and GND, if R_V , $V_{Z,VIS}$ are not used.

Reverse battery protection



 $R_V \ge 1 \text{ k}\Omega$, $R_{IS} = 1 \text{ k}\Omega$ nominal. Add R_{IN} for reverse battery protection in applications with V_{bb} above $16V^{18}$;

recommended value:
$$\frac{1}{R_{\text{IN}}} + \frac{1}{R_{\text{IS}}} + \frac{1}{R_{\text{V}}} = \frac{0.1\text{A}}{|V_{\text{bb}}| - 12\text{V}}$$
 if D_S is not used (or $\frac{1}{R_{\text{IN}}} = \frac{0.1\text{A}}{|V_{\text{bb}}| - 12\text{V}}$ if D_S is used).

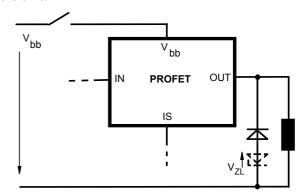
To minimize power dissipation at reverse battery operation, the overall current into the IN and IS pin should be about 120mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through $R_{\rm IS}$ and $R_{\rm V}$.

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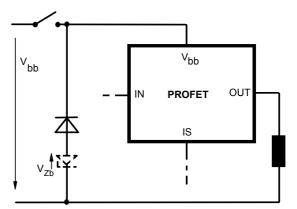
V_{bb} disconnect with energized inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ($V_{\rm ZL}$ < 70 V or $V_{\rm Zb}$ < 42 V if R_{IN}=0). For higher clamp voltages currents at IN and IS have to be limited to 250 mA.

Version a:

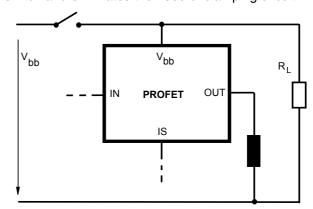


Version b:



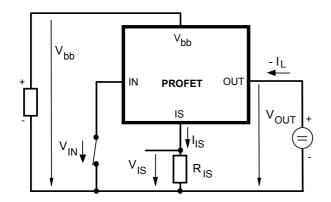
Note that there is no reverse battery protection when using a diode without additional Z-diode V_{ZL} , V_{Zb} .

Version c: Sometimes a necessary voltage clamp is given by non inductive loads R_L connected to the same switch and eliminates the need of clamping circuit:





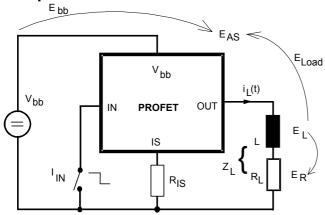
Inverse load current operation



The device is specified for inverse load current operation ($V_{\rm OUT} > V_{\rm bb} > 0V$). The current sense feature is not available during this kind of operation ($I_{\rm IS} = 0$). With $I_{\rm IN} = 0$ (e.g. input open) only the intrinsic drain source diode is conducting resulting in considerably increased power dissipation. If the device is switched on ($V_{\rm IN} = 0$), this power dissipation is decreased to the much lower value $R_{\rm ON(INV)} * P$ (specifications see page 4).

Note: Temperature protection during inverse load current operation is not possible!

Inductive load switch-off energy dissipation



Energy stored in load inductance:

$$E_L = \frac{1}{2} \cdot L \cdot I_1^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t) dt,$$

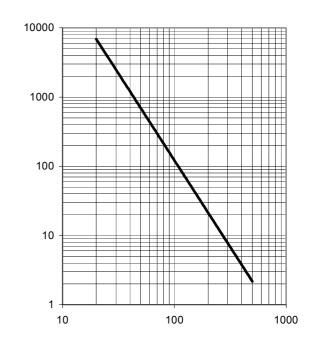
with an approximate solution for $R_L > 0 \Omega$:

$$E_{AS} = \frac{I_L \cdot L}{2 \cdot R_L} \left(V_{bb} + |V_{OUT(CL)}| \right) ln \left(1 + \frac{I_L \cdot R_L}{|V_{OUT(CL)}|} \right)$$

Data Sheet BTS50085-1TMA

Maximum allowable load inductance for a single switch off

$$L = f(I_L)$$
; T_{i,start} = 150°C, V_{bb} = 40 V, R_L = 0 Ω

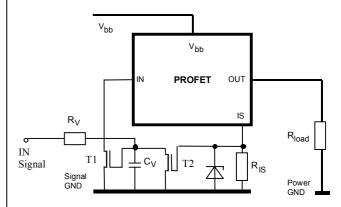


L [μH]

I [A]

Externally adjustable current limit

If the device is conducting, the sense current can be used to reduce the short circuit current and allow higher lead inductance (see diagram above). The device will be turned off, if the threshold voltage of T2 is reached by $\rm I_s^*R_{\rm ls}$. After a delay time defined by $\rm R_v^*C_v$ T1 will be reset. The device is turned on again, the short circuit current is defined by $\rm I_{L(SC)}$ and the device is shut down after $\rm t_{d(SC)}$ with latch function.





Options Overview

| Туре | BTS50085-1TMA |
|--|-------------------|
| Over temperature protection with hysteresis | Х |
| $T_{\rm j}$ >150 °C, latch function ²⁴) | |
| $T_{\rm j}$ >150 °C, with auto-restart on cooling | X |
| Short circuit to GND protection | |
| switches off when $V_{\rm ON}>6$ V typ. (when first turned on after approx. 180 μ s) | Х |
| Over voltage shutdown | - |
| Output negative voltage transient limit | |
| to V _{bb} - V _{ON(CL)} | X |
| to $V_{OUT} = -15 \text{ V typ}$ | X ²⁵) |

Latch except when $V_{\rm bb}$ - $V_{\rm OUT}$ < $V_{\rm ON(SC)}$ after shutdown. In most cases $V_{\rm OUT}$ = 0 V after shutdown ($V_{\rm OUT}$ \neq 0 V only if forced externally). So the device remains latched unless $V_{\rm bb}$ < $V_{\rm ON(SC)}$ (see page 5). No latch between turn on and $t_{d(SC)}$.

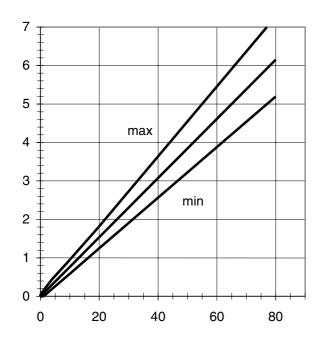
Can be "switched off" by using a diode D_S (see page 8) or leaving open the current sense output.



Characteristics

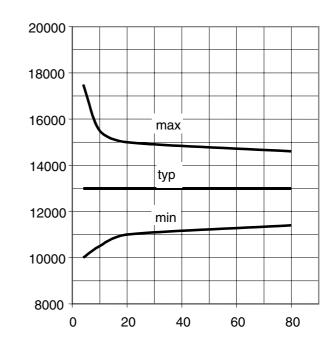
Current sense versus load current:

 $I_{\rm IS} = f(I_{\rm L}), \, {\rm T_{J}} = -40 \, \dots \, +150 \, {\rm ^{\circ}C}$ $I_{\rm IS} \, [{\rm mA}]$



Current sense ratio:

 $K_{ILIS} = f(I_L), T_j = 25^{\circ}C$

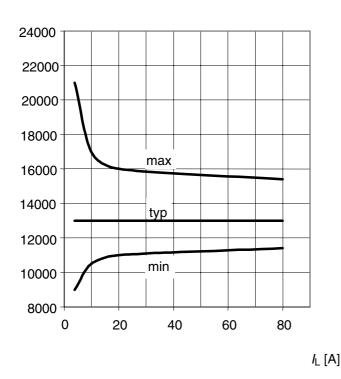


I_L [A] | k_{ilis}

/∟ [A]

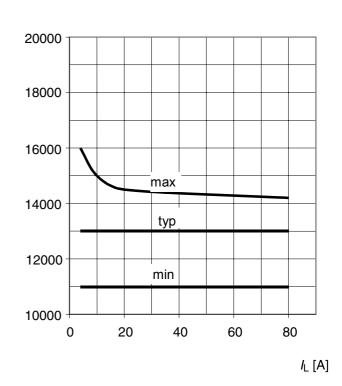
Current sense ratio:

 $K_{ILIS} = f(I_L), T_j = -40^{\circ}C$ k_{Ilis}



Current sense ratio:

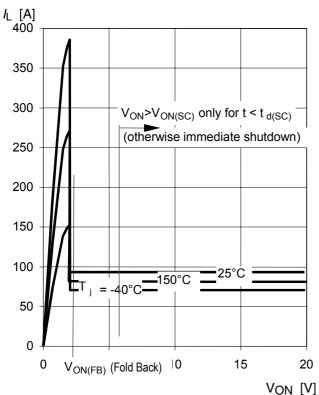
 $K_{ILIS} = f(I_L), T_j = 150$ °C k_{IIIS}





Typ. current limitation characteristic

 $I_L = f(V_{ON}, T_j)$

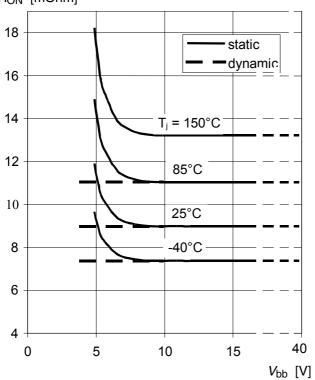


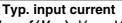
In case of $V_{ON} > V_{ON(SC)}$ (typ. 6 V) the device will be switched off by internal short circuit detection.

Typ. on-state resistance

 $R_{ON} = f(V_{bb}, T_j); I_L = 20 \text{ A}; V_{IN} = 0$

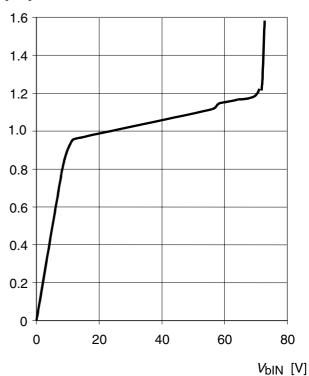
RON [mOhm]





 $I_{\text{IN}} = f(V_{\text{bIN}}), V_{\text{bIN}} = V_{\text{bb}} - V_{\text{IN}}$

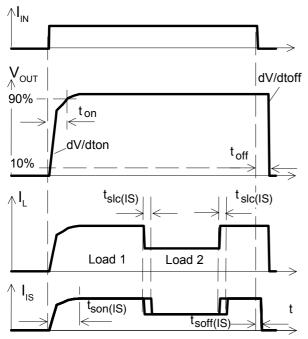
/IN [mA]





Timing diagrams

Figure 1a: Switching a resistive load, change of load current in on-condition:



The sense signal is not valid during a settling time after turn-on/off and after change of load current.

Figure 2b: Switching motors and lamps:

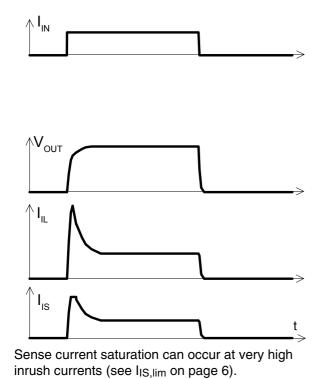


Figure 2c: Switching an inductive load:

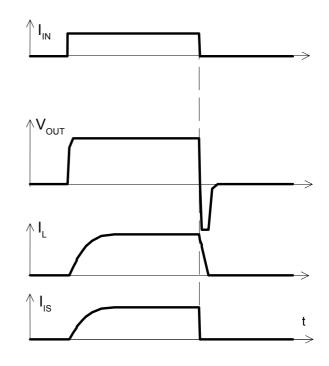
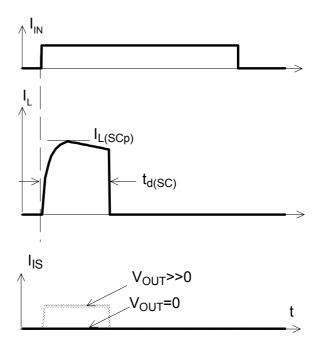


Figure 3d: Short circuit: shut down by short circuit detection, reset by $I_{IN} = 0$.



Shut down remains latched until next reset via input.



Figure 4e: Overtemperature Reset if $T_j < T_{jt}$

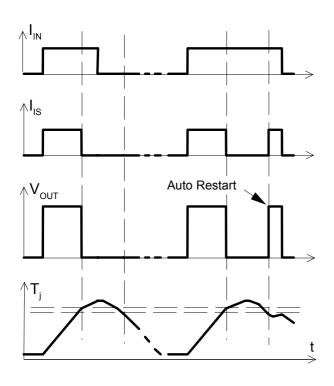
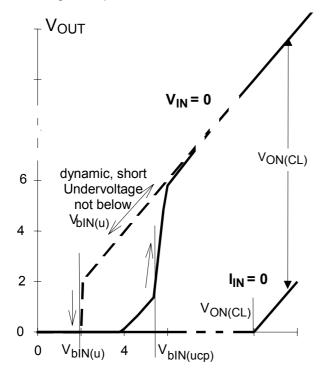


Figure 6f: Undervoltage restart of charge pump, overvoltage clamp



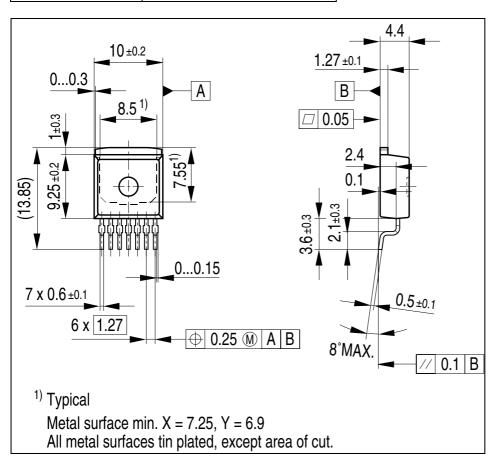


Package and Ordering Code

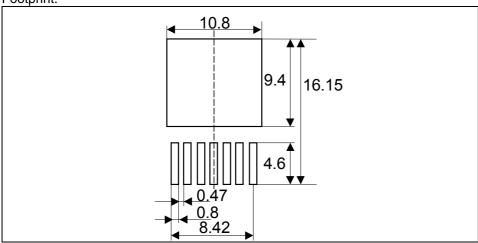
All dimensions in mm

PG-TO220-7-4

Sales Code BTS50085-1TMA



Footprint:



Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pbfree finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).





Revision History

| Version | Date | Changes |
|----------|------------|---|
| Rev. 1.0 | 2008-01-24 | Initial version of data sheet. |
| | | Green (RoHS compliant) variant of BTS660P |

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